

**Paired sparse-path signals**  
*(damaged and intact)*

**Unified preprocessing**

- Band-pass filtering
- Robust normalisation
- Temporal alignment
- Differential scatter + Hilbert envelope

Sensor layout + effective group velocity

**Delay-constrained single-path imaging**  
 $\hat{I}_{ij}(x)$

**Reliability-aware multi-path fusion**  
 $I_w(x)$

SEM-assisted auxiliary data  
(refinement stage only)

**Physics-guided enhancement**  
 $\hat{I}_{ij}(x)$

**Final defect localisation**